# **Ultra Low-Noise Low Dropout Voltage Regulator** with 1.0 V ON/OFF Control

The NCP4561 is a Low DropOut (LDO) regulator featuring excellent noise performances. Thanks to its innovative concept, the circuit reaches an incredible 40 µVRMS noise level without an external bypass capacitor. Housed in a small SOT-23 5 leads-like package, it represents the ideal designer's choice when space and noise are at premium.

The absence of external bandgap capacitor unleashes the response time to a wake-up signal and makes it stay within 40 µs (in repetitive mode), pushing the NCP4561 as a natural candidate in portable applications.

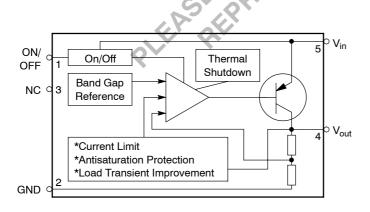
The NCP4561 also hosts a novel architecture which prevents excessive undershoots when the regulator is the seat of fast transient bursts, as in any bursting systems.

Finally, with a static line regulation better than -75 dB, it naturally shields the downstream electronics against choppy lines.

#### Features

- Ultra Low-Noise: 150 nV/√Hz @ 100 Hz, 40 μVRMS 100 Hz -100 kHz Typical, Iout = 60 mA,  $C_0 = 1.0 \mu F$
- Fast Response Time from OFF to ON: 40 µs Typical at a 200 Hz **Repetition Rate**
- Ready for 1.0 V Platforms: ON with a 900 mV High Level
- JIN SENTAINE OF • Nominal Output Current of 80 mA with a 100 mA Peak Capability
- Typical Dropout of 90 mV @ 30 mA, 160 mV @ 80 mA
- Ripple Rejection: 70 dB @ 1.0 kHz
- 1.5% Output Precision @ 25°C

- Noise Sensitive Circuits: VCOs RF Stages, etc.
  Bursting Systems (TDMA Phones)
  All Battery Orac
- All Battery Operated Devices



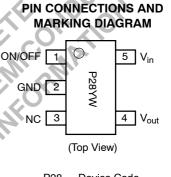




# **ON Semiconductor®**

http://onsemi.com





P28 = Device Code = Year

= Work Week

#### **ORDERING INFORMATION**

Device	Voltage Output*	Shipping
NCP4561SN28T1	2.8 V	3000/Tape & Reel

\* Contact your ON Semiconductor sales representative for other output voltage values.

#### **PIN FUNCTION DESCRIPTIONS**

Pin #	Pin Name	Function	Description
1	ON/OFF	Shuts or wakes–up the IC	A 900 mV level on this pin is sufficient to start the IC. A 150 mV shuts it down.
2	GND	The IC's ground	
3	NC	None	It makes no arm to connect the pin to a known potential, like in a pin-to-pin replacement case.
4	V <sub>out</sub>	Delivers the output voltage	This pin requires a 1.0 $\mu F$ output capacitor to be stable.
5	V <sub>in</sub>	Powers the IC	A positive voltage up to 12 V can be applied upon this pin.

#### MAXIMUM RATINGS

MAXIMUM RATINGS						
			Va			
Rating	Pin #	Symbol	Min	Max	Unit	
Power Supply Voltage	5	V <sub>in</sub>	-	12	V	
ESD Capability, HBM Model	All Pins		-	1.0	kV	
ESD Capability, Machine Model	All Pins		-	200	V	
Maximum Power Dissipation NW Suffix, Plastic Package Thermal Resistance Junction-to-Air		P <sub>D</sub> R <sub>θJ-A</sub>	ETE-OND	Internally Limited 210	W °C/W	
Operating Ambient Temperature Maximum Junction Temperature (Note 1) Maximum Operating Junction Temperature (Note 2)		T <sub>A</sub> TJmax TJ	ENIC-RNP	-40 to +85 150 125	°C	
Storage Temperature Range		T <sub>stg</sub>	20	-60 to +150	°C	

#### **ELECTRICAL CHARACTERISTICS**

(For Typical Values  $T_A = 25^{\circ}$ C, for Min/Max values  $T_A = -40^{\circ}$ C to  $+85^{\circ}$ C, Max  $T_J = 125^{\circ}$ C unless otherwise noted)

Characteri	stics	Pin #	Symbol	Min	Тур	Max	Unit
ogic Control Specifications							
Input Voltage Range		1	V <sub>ON/OFF</sub>	0	-	V <sub>in</sub>	V
ON/OFF Input Resistance	$-\langle x, \nabla x, \nabla x \rangle$	1	R <sub>ON/OFF</sub>	-	250	-	kΩ
ON/OFF Control Voltages (Note 3) Logic Zero, OFF State, $I_0 = 50 \text{ mA}$ Logic One, ON State, $I_0 = 50 \text{ mA}$	CONSER	1	V <sub>ON/OFF</sub>	_ 900		150 -	mV
Currents Parameters	CV AN				•		

#### **Currents Parameters**

Current Consumption in OFF State OFF Mode Current: $V_{in} = V_{out} + 1.0 V$ , $I_O = 0$ , $V_{OFF} = 150 mV$	IQ <sub>OFF</sub>	-	0.1	2.0	μΑ
Current Consumption in ON State ON Mode Current: $V_{in} = V_{out} + 1.0 V$ , $I_O = 0$ , $V_{ON} = 3.5 V$	IQ <sub>ON</sub>	-	180	-	μA
Current Consumption in ON State, ON Mode Saturation Current: V <sub>in</sub> = V <sub>out</sub> - 0.5 V, No Output Load	IQ <sub>SAT</sub>	-	800	-	μA
Current Limit V <sub>in</sub> = Vout <sub>nom</sub> + 1.0 V, Output is brought to Vout <sub>nom</sub> – 0.3 V	I <sub>MAX</sub>	100	180	-	mA

Internally Limited by Shutdown.
 Specifications are guaranteed below this value.
 Voltage Slope should be Greater than 2.0 mV/μs.

#### ELECTRICAL CHARACTERISTICS (continued)

(For Typical Values  $T_A = 25^{\circ}$ C, for Min/Max values  $T_A = -40^{\circ}$ C to  $+85^{\circ}$ C, Max  $T_J = 125^{\circ}$ C unless otherwise noted)

Characteristics	Pin #	Symbol	Min	Тур	Max	Unit
Dutput Voltages						
$V_{out}$ + 1.0 V < $V_{in}$ < 6.0 V, $T_A$ = 25°C, 1.0 mA < $I_{out}$ < 80 mA	4	V <sub>out</sub>	2.758	2.8	2.842	V
$V_{out}$ + 1.0 V < $V_{in}$ < 6.0 V, $T_A$ = -40°C to +85°C, 1.0 mA < $I_{out}$ < 80 mA	4	V <sub>out</sub>	2.716	2.8	2.884	V
ine and Load Regulation, Dropout Voltages						
Line Regulation $V_{out}$ + 1.0 V < $V_{in}$ < 12 V, $I_{out}$ = 80 mA	4/5	Reg <sub>line</sub>	-	-	20	mV
Load Regulation $V_{in} = V_{out} + 1.0 \text{ V}, C_{out} = 1.0 \mu\text{F}, I_{out} = 1.0 \text{ to } 80 \text{ mA}$	4	Reg <sub>load</sub>	-	-	40	mV
Dropout Voltage (Note 4) I <sub>out</sub> = 30 mA I <sub>out</sub> = 60 mA I <sub>out</sub> = 80 mA	4 4 4	V <sub>in</sub> -V <sub>out</sub> V <sub>in</sub> -V <sub>out</sub> V <sub>in</sub> -V <sub>out</sub>	-	90 140 160	150 200 250	mV
Dynamic Parameters					or l	
Ripple Rejection V <sub>in</sub> = V <sub>out</sub> + 1.0 V + 1.0 kHz 100 mVpp Sinusoidal Signal	4/5	Ripple	-	-70	-	dB
Output Noise Density @ 1.0 kHz	4			150	-	nV/ √Hz
RMS Output Noise Voltage $C_{out}$ = 1.0 $\mu$ F, I <sub>out</sub> = 50 mA, F = 100 Hz to 1.0 MHz	4	Noise		35	-	μV
Output Rise Time $C_{out}$ = 1.0 $\mu$ F, $I_{out}$ = 50 mA, 10% of Rising ON Signal to 90% of Nominal V <sub>out</sub>	4	t <sub>rise</sub>	OR OR	40	-	μs
Thermal Shutdown	5	$\sim$ $\sim$	2			
Thermal Shutdown	6		-	-	125	°C
Thermal Shutdown Thermal Shutdown . V <sub>out</sub> is brought to V <sub>out</sub> – 100 mV.						

# DEFINITIONS

#### Load Regulation

The change in output voltage for a change in output current at a constant chip temperature.

#### **Dropout Voltage**

The input/output differential at which the regulator output no longer maintains regulation against further reductions in input voltage. Measured when the output drops 100 mV below its nominal value (which is measured at 1.0 V differential value). The dropout level is affected by the chip temperature, load current and minimum input supply requirements.

#### **Output Noise Voltage**

This is the integrated value of the output noise over a specified frequency range. Input voltage and output current are kept constant during the measurement. Results are expressed in µVRMS.

#### **Maximum Power Dissipation**

The maximum total dissipation for which the regulator will operate within its specs.

#### **Quiescent Current**

ered .patio its ma .nding on the .aculate the maxin maximum available to .red The quiescent current is the current which flows through the ground when the LDO operates without a load on its output: internal IC operation, bias, etc. When the LDO becomes loaded, this term is called the Ground current. It is actually the difference between the input current (measured through the LDO input pin) and the output current.

#### Line Regulation

The change in output voltage for a change in input voltage. The measurement is made under conditions of low dissipation or by using pulse technique such that the average chip temperature is not significantly affected. One usually distinguishes static line regulation or DC line regulation (a DC step in the input voltage generates a corresponding step in the output voltage) from ripple rejection or audio *susceptibility* where the input is combined with a frequency generator to sweep from a few hertz up to a defined boundary while the output amplitude is monitored.

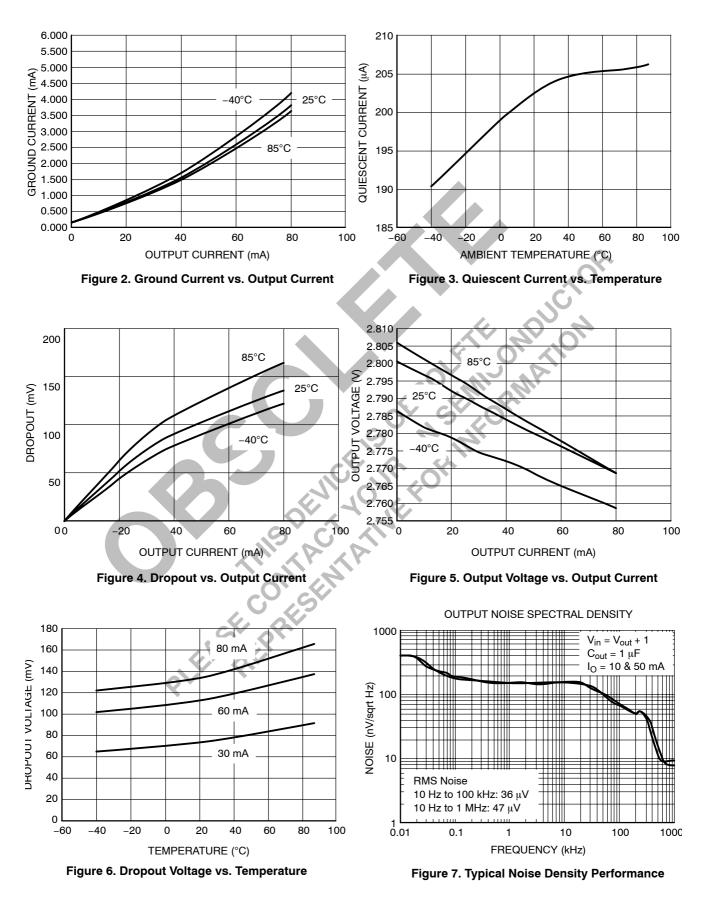
#### **Thermal Protection**

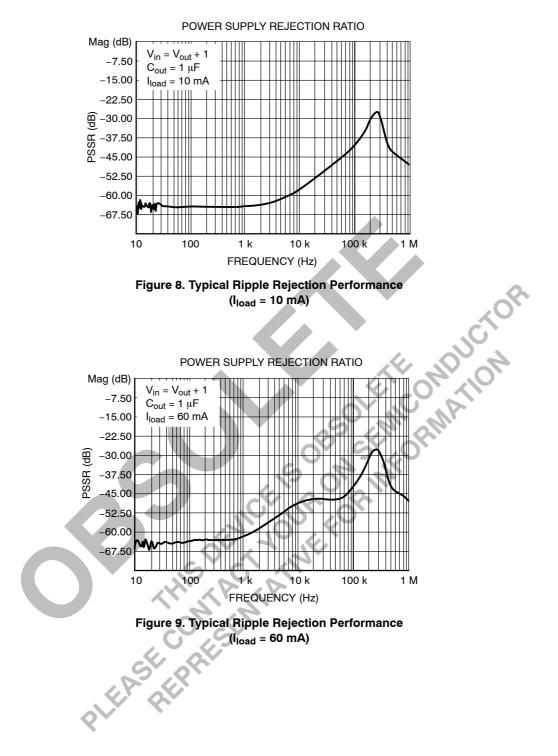
Internal thermal shutdown circuitry is provided to protect the integrated circuit in the event that the maximum junction temperature is exceeded. When activated at typically 125°C, the regulator turns off. This feature is provided to prevent catastrophic failures from accidental overheating.

## Maximum Package Power Dissipation

The maximum power package power dissipation is the power dissipation level at which the junction temperature reaches its maximum operating value, i.e. 125°C. Depending on the ambient temperature, it is possible to calculate the maximum power dissipation and thus the maximum available output current.

#### **TYPICAL CHARACTERISTICS**





### **APPLICATION HINTS**

or

#### Input Decoupling

As with any regulator, it is necessary to reduce the dynamic impedance of the supply rail that feeds the component. A 1.0 µF capacitor either ceramic or tantalum is recommended and should be connected close to the NCP4561 package. Higher values will correspondingly improve the overall line transient response.

#### **Output Decoupling**

Thanks to a novel concept, the NCP4561 is a stable component and does not require any specific Equivalent Series Resistance (ESR) neither a minimum output current. Capacitors exhibiting ESRs ranging from a few m $\Omega$  up to 3.0  $\Omega$  can thus safely be used. The minimum decoupling value is 1.0 µF and can be augmented to fulfill stringent load transient requirements. The regulator accepts ceramic chip capacitors as well as tantalum devices.

#### **Noise Decoupling**

Unlike other LDOs, the NCP4561 is a true low-noise regulator. Without the need of an external bypass capacitor, it typically reaches the incredible level of 40 µVRMS overall noise between 100 Hz and 100 kHz. To give maximum insight on noise specifications, ON Semiconductor includes a 80 mA stracted from, a NCP4561SN, a 25°C, the max spectral density graphics. The classical bypass capacitor impacts the start-up phase of standard LDOs. However, thanks to its low-noise architecture, the NCP4561 operates without a bypass element and thus offers a typical 40 µs start-up phase.

#### Protections

The NCP4561 hosts several protections, giving natural ruggedness and reliability to the products implementing the component. The output current is internally limited to a maximum value of 180 mA typical while temperature shutdown occurs if the die heats up beyond 125°C. These values let you assess the maximum differential voltage the device can sustain at a given output current before its protections come into play.

The maximum dissipation the package can handle is given by:

$$P_{max} = \frac{T_{Jmax} - T_A}{R_{\theta JA}}$$

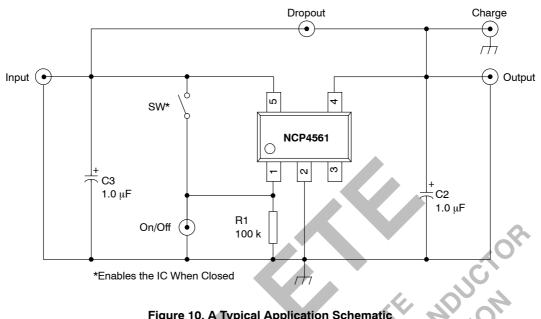
If T<sub>Imax</sub> is limited to 125°C, then the NCP4561 can dissipate up to 470 mW @ 25°C. The power dissipated by the NCP4561 can be calculated from the following formula:

$$Ptot = \left(V_{in} \times I_{gnd}(I_{out})\right) + \left(V_{in} - V_{out}\right) \times I_{out}$$
$$Vin_{max} = \frac{Ptot + V_{out} \times I_{out}}{I_{gnd} + I_{out}}$$

If a 80 mA output current is needed, the ground current is extracted from the data-sheet curves: 4.0 mA @ 80 mA. For a NCP4561SN28T1 (2.8 V) delivering 80 mA and operating at 25°C, the maximum input voltage will then be 8.3 V.

#### **Typical Applications**

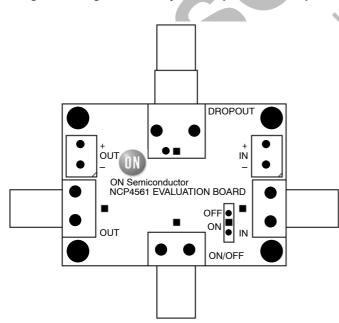
The following figure portrays the typical application of the NCP4561.





#### **PCB Layout Considerations**

As for any low noise designs, particular care has to be taken when tackling Printed Circuit Board (PCB) layout. The figure below gives an example of a layout where stray



inductances/capacitances are minimized. This layout is the basis for the NCP4561 performance evaluation board. The BNC connectors give the user an easy and quick evaluation mean.

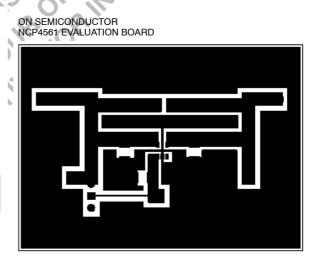


Figure 11. PCB Layout

#### Understanding the Load Transient Improvement

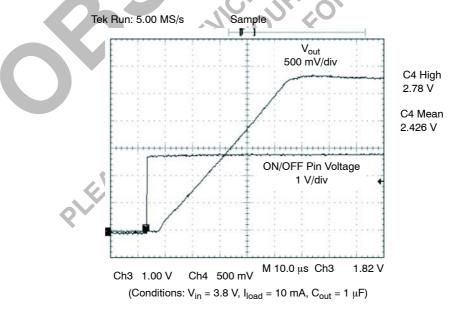
The NCP4561 features a novel architecture which allows the user to easily implement the regulator in burst systems where the time between two current shots is kept very small.

The quality of the transient response time is related to many parameters, among which the closed–loop bandwidth with the corresponding phase margin plays an important role. However, other characteristics also come into play like the series pass transistor saturation. When a current perturbation suddenly appears on the output, e.g. a load increase, the error amplifier reacts and actively biases the PNP transistor. During this reaction time, the LDO is in open–loop and the output impedance is rather high. As a result, the voltage brutally drops until the error amplifier effectively closes the loop and corrects the output error. When the load disappears, the opposite phenomenon takes place with a positive overshoot. The problem appears when this overshoot decays down to the LDO steady–state value. During this decreasing phase, the LDO stops the PNP bias and one can consider the LDO asleep. If by misfortune a current shot appears, the reaction time is incredibly lengthened and a strong undershoot takes place. This reaction is clearly not acceptable for line sensitive devices, such as VCOs or other Radio–Frequency parts. This problem is dramatically exacerbated when the output current drops to zero rather than a few mA. In this later case, the internal feedback network is the only discharge path, accordingly lengthening the output voltage decay period.

The NCP4561 cures this problem by implementing a clever design where the LDO detects the presence of the overshoot and forces the system to go back to steady–state as soon as possible, ready for the next shot, which positively improves the response time and decreases the negative peak voltage.

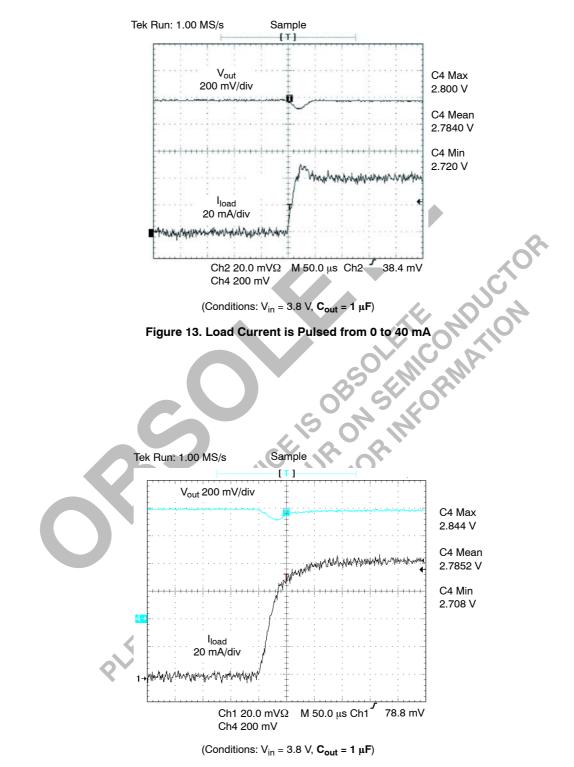
#### NCP4561 has a fast start-up phase

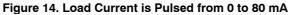
Thanks to the lack of bypass capacitor the NCP4561 is able to supply its downstream circuitry as soon as the OFF to ON signal appears. In a standard LDO, the charging time of the external bypass capacitor hampers the response time. A simple solution consists in suppressing this bypass element but, unfortunately, the noise rises to an unacceptable level. NCP4561 offers the best of both worlds since it no longer includes a bypass capacitor and starts in less than 40  $\mu$ s typically (Repetitive at 200 Hz). It also ensures a low-noise level of 40  $\mu$ VRMS 100 Hz-100 kHz. The following picture details the typical NCP4561 startup phase.



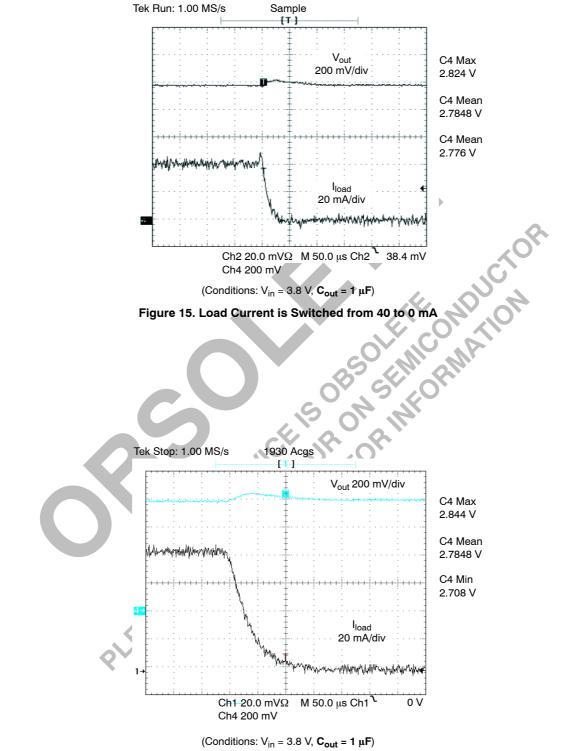


#### **TYPICAL TRANSIENT RESPONSES**





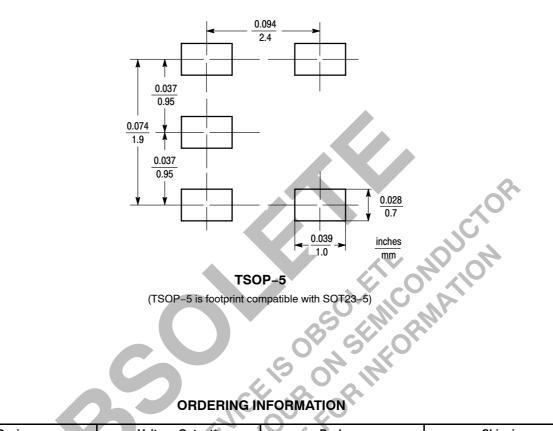
#### **TYPICAL TRANSIENT RESPONSES**





#### MINIMUM RECOMMENDED FOOTPRINT FOR SURFACE MOUNTED APPLICATIONS

Surface mount board layout is a critical portion of the total design. The footprint for the semiconductor packages must be the correct size to insure proper solder connection interface between the board and the package. With the correct pad geometry, the packages will self align when subjected to a solder reflow process.

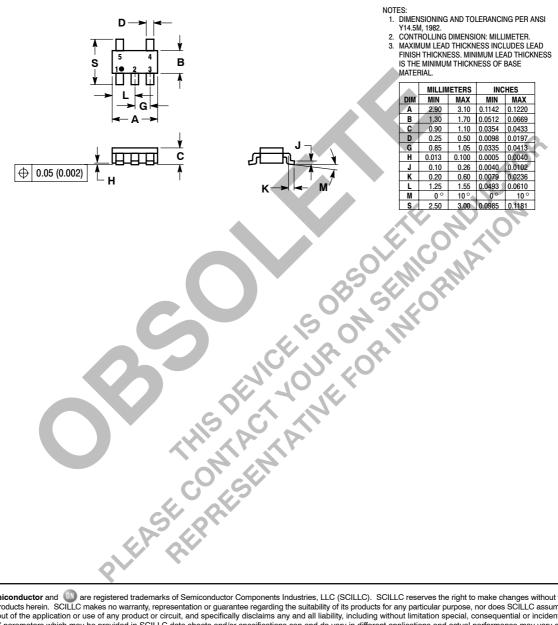


# **ORDERING INFORMATION**

ICP4561SN28T1	2.8 V	TSOP-5	3000 Units /Tape & Reel
ntact your ON Semiconductor sa	les representative for other outp		
	CONSEN	ut voltage values.	
2	th REPH		

#### PACKAGE DIMENSIONS

TSOP-5 SN SUFFIX PLASTIC PACKAGE CASE 483-01 ISSUE B



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